

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT7084438

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ZHICONG LUO	10/08/2021
JINGHU LI	10/08/2021
ZHANG FAN	10/08/2021
FUJIE CHEN	10/08/2021
QIPENG LIN	10/08/2021
AN LIN	10/08/2021
JIANHAI YU	10/08/2021
HANGHUI TU	10/08/2021
RECEIVING PARTY DATA	
Name:	XIAMEN EOCHIP SEMICONDUCTOR CO., LTD
Street Address:	UNIT 102, NO.1736, GANGZHONG RD.
Internal Address:	XIAMEN AREA, PILOT FREE TRADE ZONE
City:	XIAMEN CITY, FUJIAN PROVINCE
State/Country:	CHINA
Postal Code:	361000
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17621209
CORRESPONDENCE DATA	
Fax Number:	(888)415-1813
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	626-415-7236
Email:	patent@novoclaims.com
Correspondent Name:	NOVOCLAIMS PATENT SERVICES LLC
Address Line 1:	20539 E. WALNUT DRIVE NORTH, SUITE I
Address Line 2:	(WALNUT PARK BUSINESS CENTER)
Address Line 4:	WALNUT, CALIFORNIA 91789
ATTORNEY DOCKET NUMBER:	BZC-USU-A641-EOC
NAME OF SUBMITTER:	MEI LIN WONG

PATENT

SIGNATURE:	/Mei Lin Wong/
DATE SIGNED:	12/20/2021
Total Attachments: 2 source=a641-assignment-2021-10-08#page1.tif source=a641-assignment-2021-10-08#page2.tif	

ASSIGNMENT

WHEREAS #1:Zhicong LUO; #2: Jinghu LI; #3:Zhang FAN; #4:Fujie CHEN; #5:Qipeng LIN; #6: An LIN; #7:Jianhai YU; and #8:Hanghui TU, the assignor(s), whose mailing address is Unit 102, No.1736, Gangzhong Road, Xiamen Area, Pilot Free Trade Zone Xiamen City, Fujian Province, 361000, China,

have invented certain new and useful improvements in an invention relating to and entitled High-speed Optical Transceiver Integrated Chip Drive Circuit with Phase Delay Compensation Function, the invention, as fully set forth and described in an application for Letters Patent to be filed at the United States Patent and Trademark Office as US National Stage under 35 USC 371 of PCT/CN2021/073228 and naming the assignors as inventors;

AND WHEREAS XIAMEN ECHIP SEMICONDUCTOR CO., LTD of China, the assignee, whose mailing address is Unit 102, No.1736, Gangzhong Road, Xiamen Area, Pilot Free Trade Zone Xiamen City, Fujian Province, 361000, China,

is desirous of acquiring the entire right, title and interest in and to said invention, and in and to Any Letters Patent that may be obtained there for;

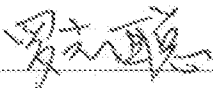
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, receipt of which is hereby acknowledged, the assignors, do hereby confirm that they have sold, assigned and transferred, and do hereby sell, assign and transfer to the assignee the full and exclusive right to the said invention in the United States and their entire right, title and interest for the United States in and to the invention, together with their entire right, title and interest in and to said application, any and all divisional applications thereof, and any and all Letters Patent of the United States which may issue or be reissued for the invention;

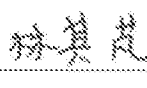
AND the assignors hereby authorize and request the Director of the United States Patent and Trademark Office to issue to said assignee of any and all said Letters Patent not already issued as the assignee of their entire right, title and interest in and to the same, for the sole use and benefit of said assignee, its successors, assigns or legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by the assignors had this assignment and sale not been made.

AND the assignors, on behalf of themselves and their executors and administrators, hereby covenant and agree to do all such lawful acts and things and to execute without further consideration such further lawful assignments, documents, assurances, applications, and other instruments as may reasonably be required by said assignee, its successors, assigns or legal representatives, to obtain any and all Letters Patent of the United States for said invention and vest the same in said assignee, its successors, assigns or legal representatives.

SIGNED on this [08] day of [October] , 2021


SIGNED on this [08] day of [October] , 2021

 [Signature #1]
Zhicong LUO

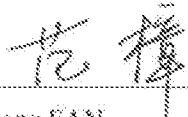
 [Signature #5]
Qipeng LIN

SIGNED on this [08] day of [October] , 2021


SIGNED on this [08] day of [October] , 2021

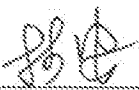

.....[Signature #2]
Jinghui LI

SIGNED on this [08] day of [October] , 2021

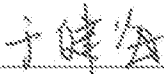

.....[Signature #3]
Zhang FAN

SIGNED on this [08] day of [October] , 2021



.....[Signature #4]
Fujie CHEN


.....[Signature #6]
An LIN

S
IGNED on this [08] day of [October] , 2021


.....[Signature #7]
Jianhai YU

SIGNED on this [08] day of [October] , 2021


.....[Signature #8]
Hanghui TU